

Features

- 0201 0.35mm SMD LED
- High Brightness
- AllnGaP Technology
- Small package
- High reliability
- Clear Lens

Applications

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

Description

The IN-S21AT5R is a popular low profile 0201 package with versatile design capabilities. It is a PCB type molding style LED which can be used in various applications.

Recommended Solder Pattern

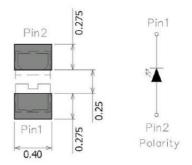
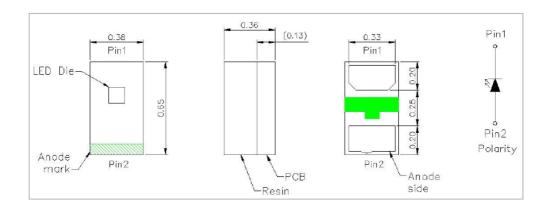


Figure 1. IN-S21AT5R Solder Pattern



Package Dimensions in mm

Notes.

- 1. All dimensions are in millimeters.
- 2. Tolerance is ± 0.05 mm unless otherwise noted

Figure 2. IN-S21AT5R Package Dimensions



Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P _d (mW)	I _F (mA)	I _{FP} * (mA)	V _R (V)	T _{OP} (°C)	T _{st} (°C)
IN-S21AT5R	Red	4.8	2	15	5	-40°C~+80°C	-40°C~+100°C

Notes

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).



Electrical Characteristics $T_A = 25$ °C (Note 1)

	Emission		V _F	(V)		λ(nm)		Viewing Angle	l [*] _v (mcd)
Product	Color	l _F (mA)	Тур	max	λ_{D}	λ_{P}	$ riangle \lambda$	2 <i>θ</i> 1/2	typ.
IN-S21AT5R	Red	5	1.8	2.4	621	629	11	110	18

Notes

1. Performance guaranteed only under conditions listed in above tables.

Luminous Intensity (Iv) Bin:

Bin	Luminous Intensity Range (mcd)					
	Minimum	Maximum				
L	11.25	18.0				
М	18.0	28.5				
Ν	28.5	45.0				

@5mA / Ta=25^o C, Tolerance: ±10%

Forward Voltage (VF) Bin:

Color	Bin Code	Spec. Range
Red	E18	1.6-2.4V

@5mA / Ta=25 $^\circ\!\mathrm{C}$, Tolerance: $\pm\,0.05$ V

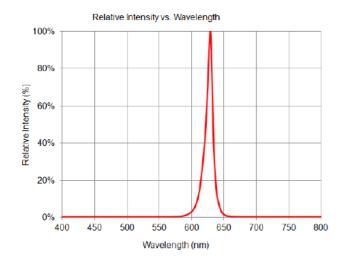
Wavelength Bin: (VF) Bin:

Color	Bin Code	Spec. Range
Red	AD	615-635nm

@5mA / Ta=25°C , Tolerance: \pm 0.5nm



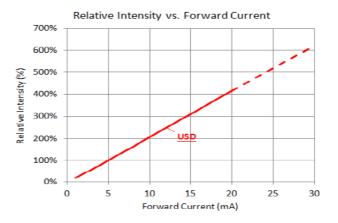
Typical Characteristic Curves



20 18 Forward Current(mA) 16 14 12 10 8 6 4 2 0 1.6 1.7 1.8 1.9 2 2.1 2.2 2.3 2.4 Forward Voltage(V)

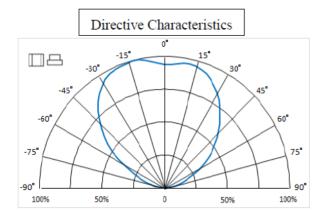
Forward voltage vs. Forward Current

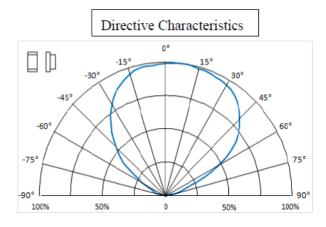
Forward Current VS. Soldering Temperture 5 Forward Current (mA) 0 0 10 20 30 40 50 60 70 80 90 100 Soldering Temperture °C





Typical Characteristic Curves – Radiation Pattern



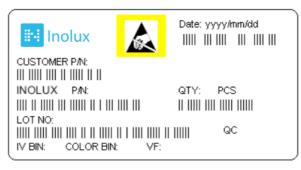


Ordering Information

Product	Emission Color	Technology	Test Current I⊧ (mA)	Luminous Intensity I _V (mcd) (Typ.)	Forward Voltage V _F (V) (Typ.)	Orderable Part Number
IN-S21AT5R	Red	AllnGaP	5	18	1.8	IN-S21AT5R



Label Specifications



Inolux P/N:

I	Ν	-	S	2	1	А	Т	5		R	-	-	-	-	-
			Material	Pac	kage	Variation	Orientation	Current	Lens	Color				nizeo p-off	
	blux VID		S = PCB Type	2:		5 x 0.38x mm	T = Top Mount	5=5mA	(Blank) = Clear U = Diffused	R = 621nm					

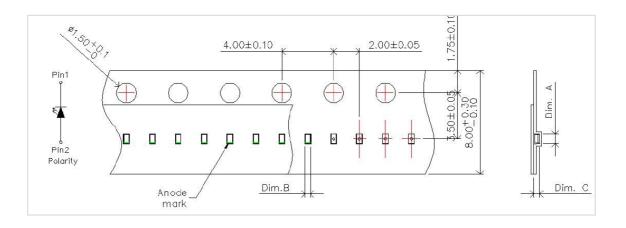
Lot No.:

Z	2	0	1	7	01	24	001
Internal		Voar (2017	, 2018,)	Month	Date	Serial	
Tracker		Teat (2017	, 2010,)		WOITT	Date	Serial



Packaging Information: 4000pcs Per Reel

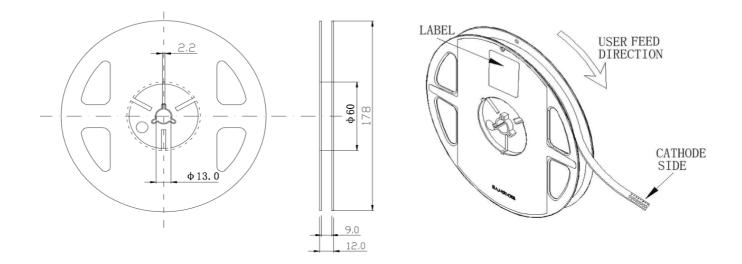
Tape Dimension



Dim. A	Dim. B	Dim. C	Q'ty/Reel
0.74±0.03	0.47±0.03	0.41±0.03	4K

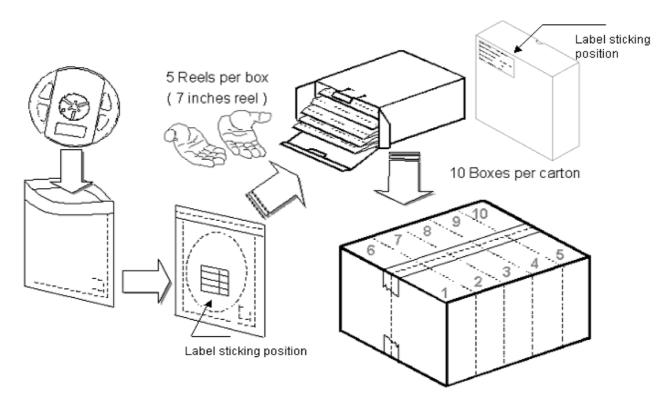
Unit: mm

Reel Dimension





Packing Dimension



5 boxes per carton are available depending on shipment quantity.

Specification	Material	Quantity
Per EIA 481-1A specs	Conductive black tape	4000pcs per reel
Per EIA 481-1A specs	Conductive black	
IN standard	Paper	
220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
IN standard	Paper	Non-specified
	Per EIA 481-1A specs Per EIA 481-1A specs IN standard 220x240mm	Per EIA 481-1A specsConductive black tapePer EIA 481-1A specsConductive blackIN standardPaper220x240mmAluminum laminated bag/ no-zipper

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

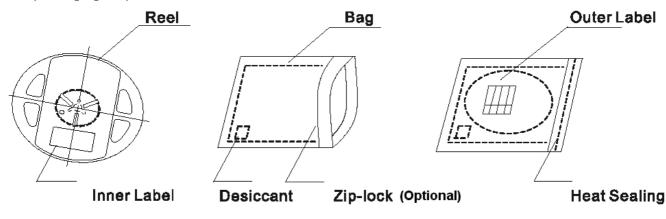


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

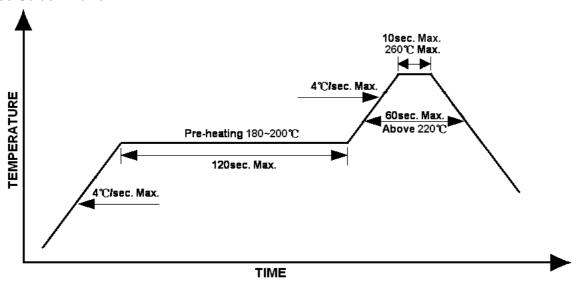
Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



Lead-free Solder Profile



Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



Reliability

Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions
Dresseritier	For all reliability	J-STD-020	1.) Baking at 85°C for 24hrs
Precondition	monitoring tests according to JEDEC Level 2		2.) Moisture storage at 85°C/ 60% R.H. for 168hrs
Solderability	1Q/ 1/ 22/ 0	JESD22-B102-B And CNS-5068	Accelerated aging 155°C/ 24hrs Tinning speed: 2.5+0.5cm/s
Solderability			Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
Decistores to		CNS-5067	Dipping soldering terminal only
Resistance to			Soldering bath temperature
soldering heat			A: 260+/-5°C; 10+/-1s B: 350+/-10°C; 3+/-0.5s
	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs
Operating life test	10/1/40/0	0103-11029	85°C/ 60%R.H. for 168hrs
Operating me test			2.) Tamb25°C; IF=20mA; duration 1000hrs
High humidity,	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C
high temperature			Humidity: 85% R.H., IF=5mA
bias			Duration: 1000hrs
	1Q/ 1/ 20	IN specs.	Tamb: 55°C
High temperature		-1	IF=20mA
bias			Duration: 1000hrs
	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty
Pulse life test			cycle=0.125 (tp=125 µ s,T=1sec)
			Duration 500hrs)
	1Q/ 1/ 76/ 0	JESD-A104-A	A cycle: -40 degree C 15min; +85 degree C
Temperature		IEC 68-2-14, Nb	15min
cycle			Thermal steady within 5 min
			300 cycles 2 chamber/ Air-to-air type
High humidity	1Q/ 1/ 40/ 0	CNS-6117	60+3°C
storage test			90+5/-10% R.H. for 500hrs
High temperature	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
storage test			
Low temperature storage test	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs

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Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	10-16-2019

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